

General Description

The IRF9Z24 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

Features

- P-Channel
- Fast Switching
- Simple Drive Requirements
- RoHS Compliant

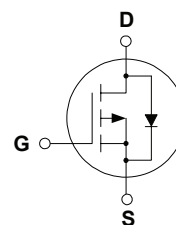
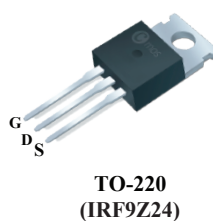
Product Summary

BVDSS	$R_{DS(on)}$ max.	ID
-60V	35mΩ	-22A

Applications

- Inverters
- Motor drive
- DC / DC converter

TO-220 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-60	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_C = 25^\circ\text{C}$	Continuous Drain Current	-22	A
I_{DM}	Pulsed Drain Current	-88	A
EAS	Single Pulse Avalanche Energy ¹	180	mJ
$P_D @ T_C = 25^\circ\text{C}$	Total Power Dissipation	60	W
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 175	$^\circ\text{C}$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction-case	---	2.5	$^\circ\text{C}/\text{W}$

Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DS}	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=-250\mu A$	-60	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=-10V$, $I_D=-15A$	---	29	35	mΩ
		$V_{GS}=-4.5V$, $I_D=-10A$	---	35	50	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=-250\mu A$	-1	---	-3	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=-60V$, $V_{GS}=0V$	---	---	-1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=-10V$, $I_D=-15A$	---	17	---	S
Q_g	Total Gate Charge	$I_D=-11A$	---	14	---	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=-48V$	---	3	---	
Q_{gd}	Gate-Drain Charge	$V_{GS}=-10V$	---	7.5	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DS}=-30V$	---	15	---	ns
T_r	Rise Time	$I_D=-11A$	---	70	---	
$T_{d(off)}$	Turn-Off Delay Time	$R_G=18\Omega$	---	18	---	
T_f	Fall Time	$R_D=2.5\Omega$	---	30	---	
C_{iss}	Input Capacitance	$V_{DS}=-25V$, $V_{GS}=0V$, $f=1\text{MHz}$	---	1100	---	pF
C_{oss}	Output Capacitance		---	140	---	
C_{rss}	Reverse Transfer Capacitance		---	2	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V$, Force Current	---	---	-22	A
I_{SM}	Pulsed Source Current		---	---	-88	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V$, $I_F=-3A$	---	-0.78	-1.3	V

Note :

1.The EAS data shows Max. rating . The test condition is $V_{DD}=-40V$, $V_{GS}=-10V$, $L=1\text{mH}$, $I_{AS}=-19A$.

This product has been designed and qualified for the consumer market.

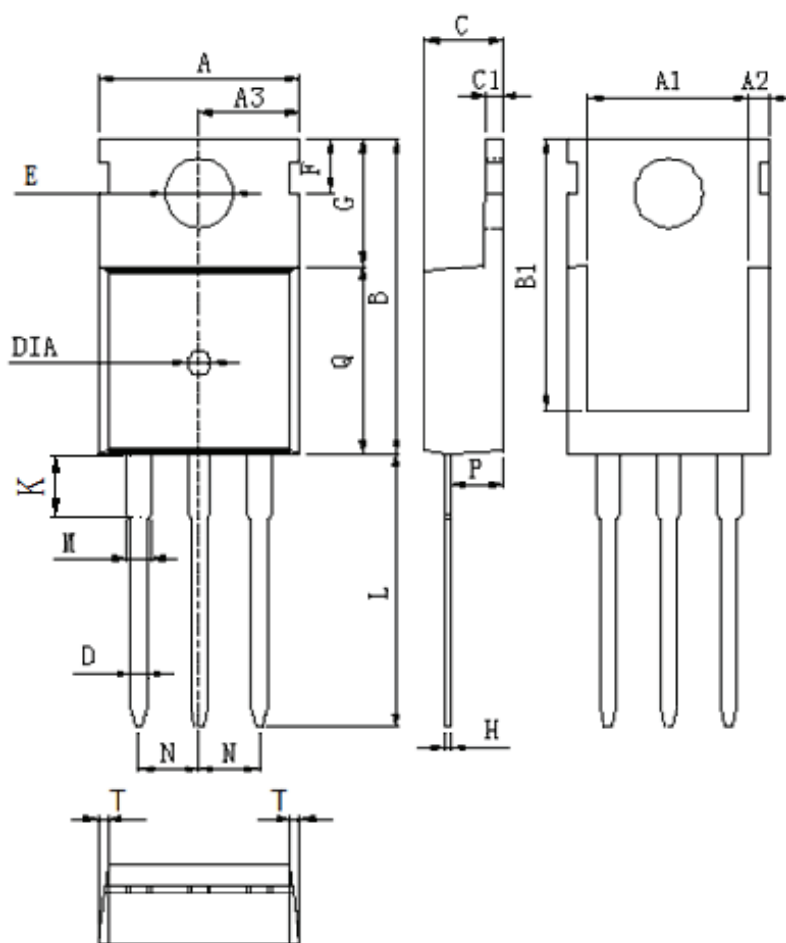
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Cmos reserves the right to improve product design ,functions and reliability without notice.Please refer to the latest version of specification.

Package Dimension

TO-220

Unit :mm



DIM	MILLIMETERS
A	10.0 ± 0.3
A1	8.64 ± 0.2
A2	1.15 ± 0.1
A3	5.0 ± 0.2
B	15.8 ± 0.4
B1	13.2 ± 0.3
C	4.56 ± 0.1
C1	1.3 ± 0.2
D	0.8 ± 0.2
E	3.6 ± 0.2
F	2.95 ± 0.3
G	6.5 ± 0.3
H	0.5 ± 0.1
K	3.1 ± 0.2
L	13.2 ± 0.4
M	1.25 ± 0.1
N	2.54 ± 0.1
P	2.4 ± 0.3
Q	9.0 ± 0.3
T	W:0.35
DIA	$\odot 1.5$ (deep 0.2)